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For PTO-1449 (Modified)	U.S. Department of Commerce Patent and Trademark Office	Atty. Docket No. 30320/15636	Serial No. 10/674,370
INFORMATION DISCLOSURE STATEMENT		Applicant Yao et al.	
		Filing Date 09/30/2003	Group Not Yet Assigned

OTHER DOCUMENTS (Including Author, Title, Date, Pertinent Pages, etc.)		
<i>ABM</i>		"Thermal VIA/BGA", Micro Substrates Corporation, website, 3 pages, © 2000, found at: http://www.microsubstrates.com/body_thermal%20via_bga.html . on 9/13/2003.
<i>ABM</i>		Technical Schematic entitled "Modification of Ceramic Detail, Thickness & Base," dated 1/29/2003, Kyocera Corporation.

Examiner <i>J. B. Melson</i>	Date Considered 2/7/05
*EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.	